

#### Description

#### **30V N-CHANNEL ENHANCEMENT MODE POWER MOSFET**

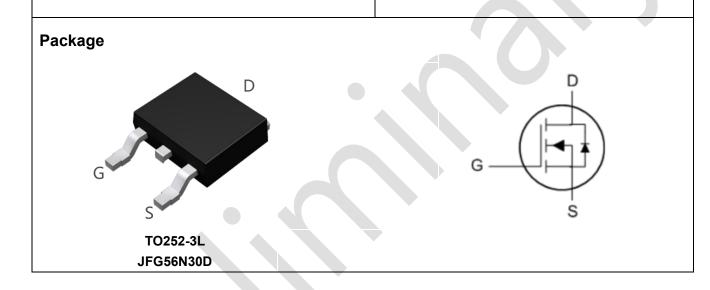
#### **Features**

- Device Rating V<sub>DS</sub> = 30V, I<sub>D</sub> = 56A
- $R_{DS(ON)} = 4.9 m\Omega$  (typ.) @ V<sub>GS</sub> = 10V, I<sub>D</sub> = 20A
- R<sub>DS(ON)</sub> =8mΩ (typ.) @ V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 20A
- Proprietary High Density Trench Technology
- RoHS Compliant & Halogen-Free

#### Application

#### BLDC

BMS



#### Absolute Maximum Ratings Tc=25°C unless otherwise specified

Symbol	Parameter Drain-Source Voltage		Max.	Units V	
VDS			30		
V <sub>G</sub> s	Gate-Source Voltage		± 20	V	
ID	Continuous Drain Current, VGS @ 10V note1	T <sub>C</sub> = 25°C	56	А	
		Tc = 100°C	35	А	
Ідм	Pulsed Drain Current note2		224	А	
P <sub>D</sub>	Power Dissipation note4	Tc = 25°C	27	W	
	Power Dissipation	T <sub>A</sub> = 25°C	3.9	W	
Eas	Single Pulsed Avalanche Energy note3		50	mJ	
Rejc	Thermal Resistance, Junction to Case note1		4.5	°C/W	
R <sub>0JA</sub>	Junction to Ambient (mounted on 1 inch square PCB)		32	°C/W	
Tj, Tstg	Operating and Storage Temperature Range		-55 to +150	°C	



#### Electrical Characteristics Tc=25°C unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic		•			
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250 \mu A$	30	-	-	V
IDSS	Drain-Source Leakage Current	$V_{DS}$ = 30V, $V_{GS}$ = 0V, $T_{C}$ = 25°C	-	-	1	μA
		V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, T <sub>C</sub> = 55°C	-	-	10	μA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-100	-	100	nA
On Charac	teristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	1.0	- )	2.5	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> =20A	-	4.9	5.9	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> =20A	-	8.0	9.6	mΩ
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> =20A		49	-	S
Dynamic C	Characteristics					
R <sub>g</sub>	Gate Resistance			1.48	-	Ω
Ciss	Input Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	-	1090	-	pF
Coss	Output Capacitance		-	225	-	pF
Crss	Reverse Transfer Capacitance		-	207	-	pF
Qg	Total Gate Charge	V <sub>DS</sub> =15V, I <sub>D</sub> = 20A, V <sub>GS</sub> = 10V	-	21.2	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	3.05	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge		-	6.86	-	nC
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time		-	16	-	ns
tr	Turn-On Rise Time	V <sub>DD</sub> = 15V, I <sub>D</sub> = 20A,	-	28	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$R_G$ = 1 $\Omega$ , $V_{GS}$ = 10V	-	36	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	20	-	ns
Source-Dr	ain Diode Characteristics and Maxin	num Ratings	•			
ls	Maximum Continuous Diode Forward Current note1,5		-	-	22	А
Ism	Maximum Pulsed Diode Forward Current note2,5		-	-	224	А
trr	Reverse Recovery Time	$T_J$ = 25°C, I <sub>S</sub> = 20A, V <sub>GS</sub> = 0V	-	50	-	ns
Qrr	Reverse Recovery Charge	T <sub>J</sub> = 25°C, I <sub>S</sub> = 20A,		50		nC
		di/dt = 150A/µs		50		
V <sub>SD</sub> <sup>note2</sup>	Source to Drain Diode Forward Voltage	$T_J = 25^{\circ}C, I_S = 20A, V_{GS} = 0V$	-	0.84	-	V

Note :

1. The data tested by surface mounted on one inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed, pulse width  $\leq$  300us, duty cycle  $\leq$  2%.

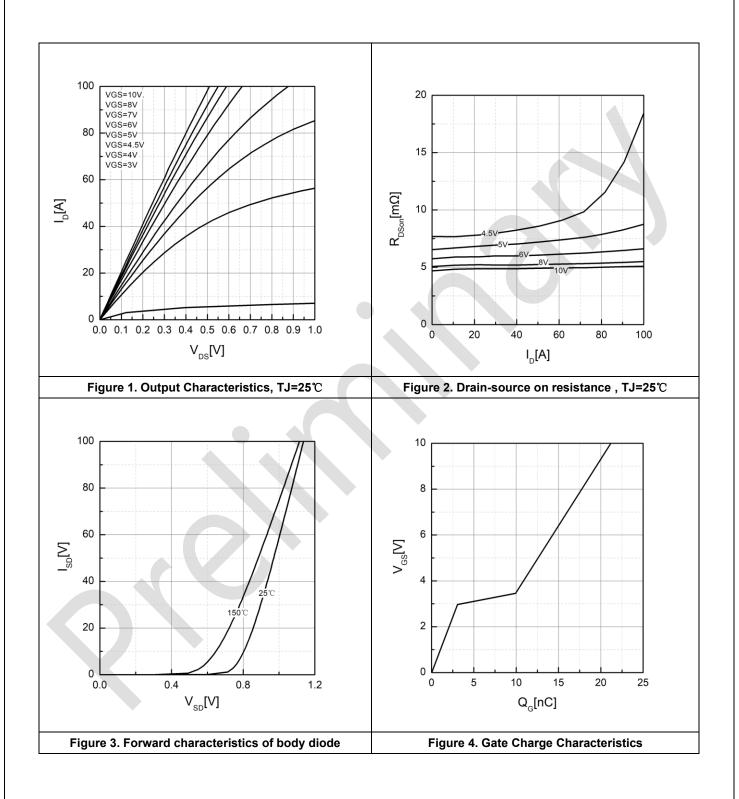
3. The EAS data shows Max. rating. The test condition is L=0.1mH, I\_{AS}= 31.6 A.

4.The power dissipation is limited by  $150^{\circ}$ C junction temperature.

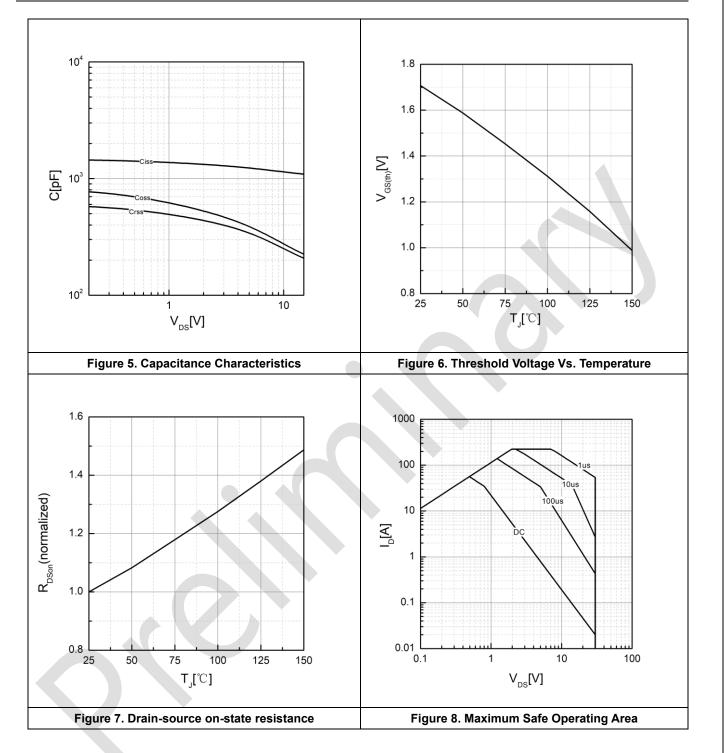
5. The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub>, in real applications, should be limited by total power dissipation.



#### **Typical Performance Characteristics**





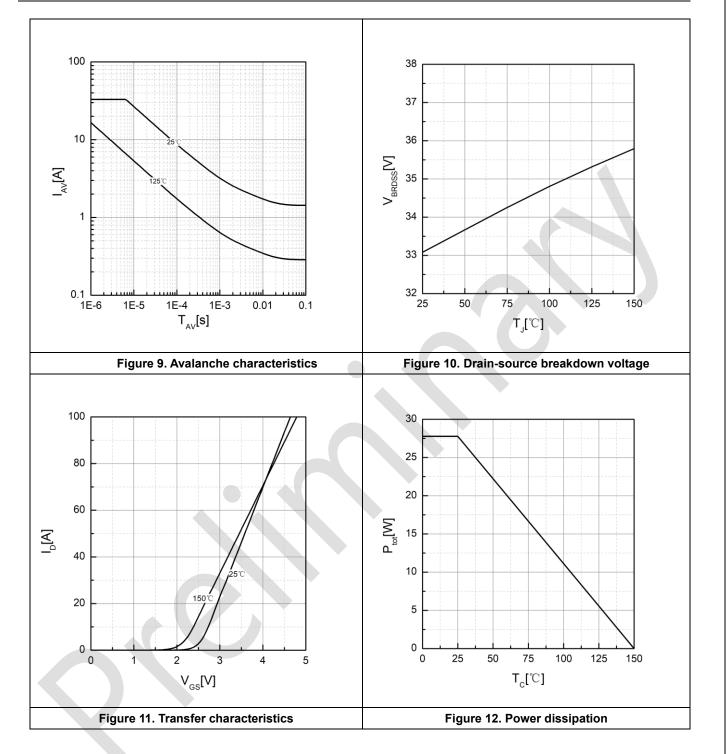


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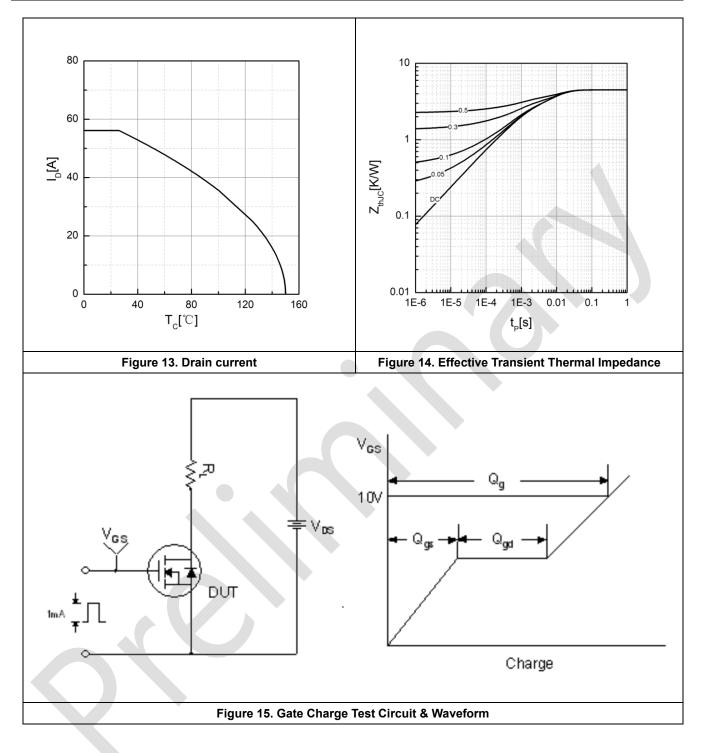
### JFG56N30D





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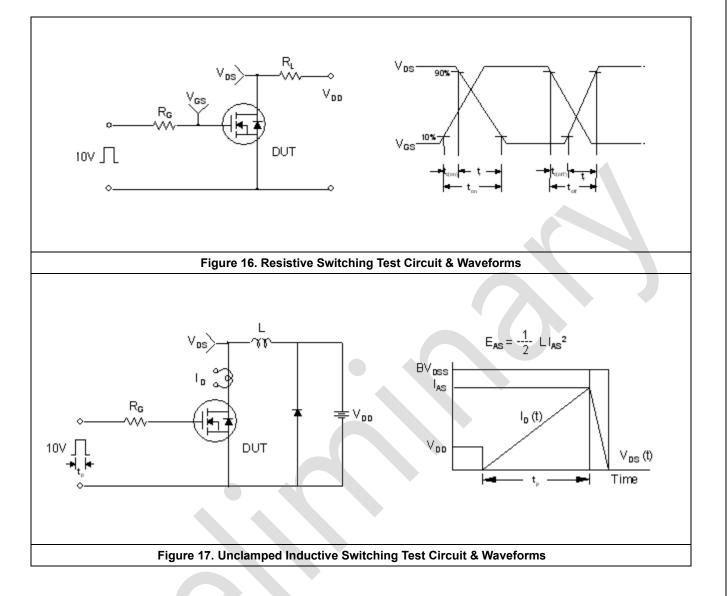
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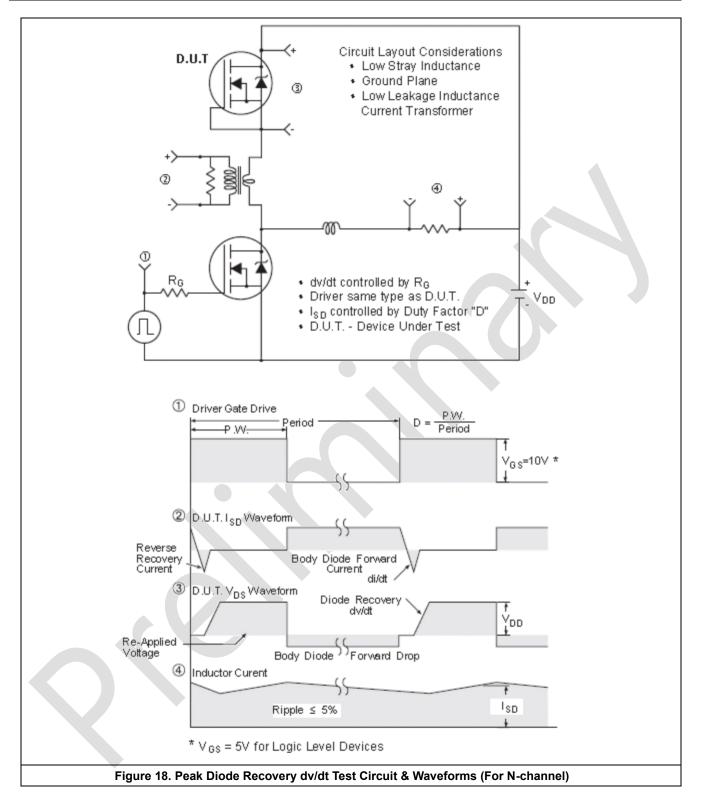
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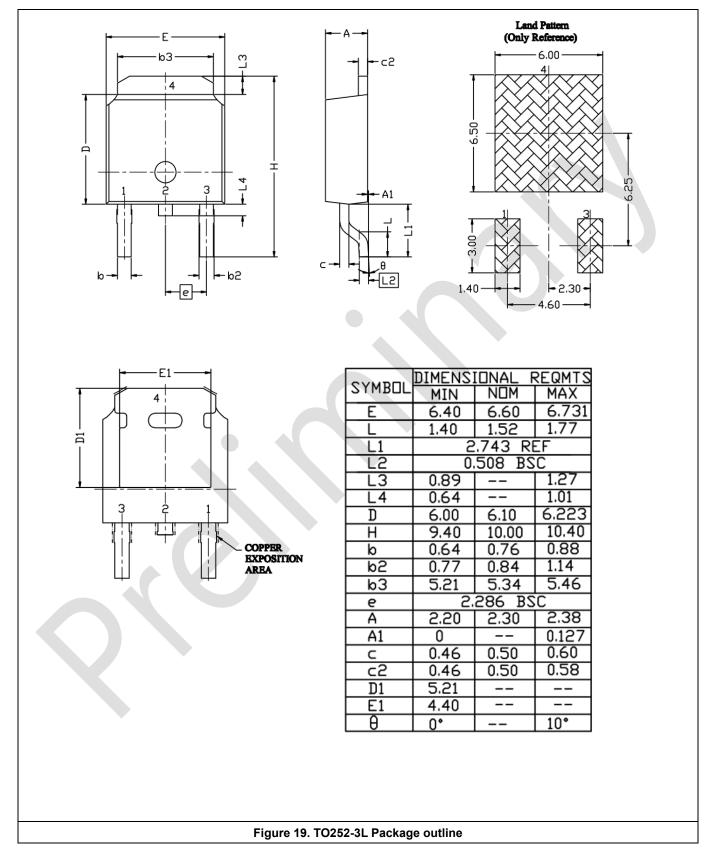
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#### Package outline



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